



Material Content Data Sheet



Sales Product Name	IPP80N06S2L-05			Issued		29. August 2013		
MA#	MA000275845							
Package	PG-TO220-3-1			Weight*		2040.62 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	12.294	0.60	0.60	6024	6024
leadframe	non noble metal	iron	7439-89-6	1.407	0.07		689	
	inorganic material	phosphorus	7723-14-0	0.422	0.02		207	
	non noble metal	copper	7440-50-8	1404.801	68.85	68.94	688420	689316
wire	non noble metal	aluminium	7429-90-5	5.402	0.26	0.26	2647	2647
encapsulation	organic material	carbon black	1333-86-4	8.803	0.43		4314	
	plastics	epoxy resin	-	96.837	4.75		47455	
	inorganic material	silicondioxide	60676-86-0	481.249	23.58	28.76	235835	287604
leadfinish	non noble metal	tin	7440-31-5	21.462	1.05	1.05	10518	10518
plating	non noble metal	nickel	7440-02-0	0.244	0.01		120	
	inorganic material	phosphorus	7723-14-0	0.001	0.00	0.01	0	120
solder	noble metal	silver	7440-22-4	0.192	0.01		94	
	non noble metal	tin	7440-31-5	0.154	0.01		75	
	non noble metal	lead	7439-92-1	7.350	0.36	0.38	3602	3771
*deviation	< 10%	Sum in total:			100,00			1000000

Important Remarks:

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